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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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Coiltronics HCMA1305 Series

Automotive grade High current power inductors



Product description

- · Automotive grade 3 qualified
- High current carrying capacity, low core losses
- · Magnetically shielded, low EMI
- Frequency range up to 5MHz
- Inductance range from 0.10μH to 33μH
- · Current range from 5.2A to 118A
- 13.8x12.5mm footprint surface mount package in a 5.0mm height
- · Powder iron core material
- · Halogen free, lead free, RoHS compliant

Applications

- Body electronics
 - Central body control module
 - Vehicle access control system
 - Headlamps, tail lamps and interior lighting
 - Heating Ventilation and Air Conditioning controllers (HVAC)
 - Doors, window lift and seat control
- Advanced driver assistance systems
 - Adaptive cruise control (ACC)
 - Automatic parking control
 - Collision avoidance system
 - Car black box system
- Infotainment and cluster electronics
 - Audio subsystem: head unit and trunk amp
 - Digital instrument cluster
 - In-Vehicle Infotainment (IVI) and navigation
- Chassis and safety electronics
 - Airbag control unit
 - Electronic Stability Control system (ESC)
 - Electric parking brake
 - Electronic Power Steering (EPS)

Environmental data

- Storage temperature range (Component): -55°C to +125°C
- Operating temperature range: -55°C to +125°C (ambient + self-temperature rise)
- Solder reflow temperature: J-STD-020D compliant









The Coiltronics brand of magnetics (formerly of the Bussmann Division of Cooper Industries) is now part of Eaton's Electrical Group, Electronics Division. Coiltronics is now part of Eaton Same great products plus even more.

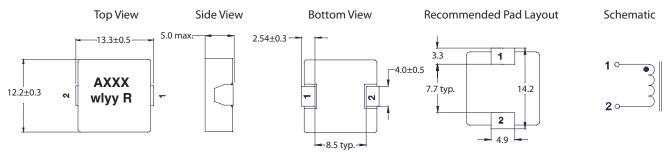


Product specifications

Part Number ⁶	OCL¹ (μΗ) ± 20%	FLL² Min. (µH)	I _{rms} ³ (amps)	l _{sat} 4 (amps)	DCR (mΩ) @ 20°C ± nominal	DCR (mΩ) @ 20°C maximum	K-factor⁵
HCMA1305-R10-R	0.10	0.064	55	118	0.52	0.59	848
HCMA1305-R22-R	0.22	0.14	51	110	0.63	0.72	843
HCMA1305-R33-R	0.33	0.21	42	80	0.80	0.92	506
HCMA1305-R47-R	0.47	0.30	38	65	0.80	0.92	506
HCMA1305-R56-R	0.56	0.36	36	55	1.15	1.33	500
HCMA1305-R68-R	0.68	0.44	34	54	1.15	1.33	500
HCMA1305-R82-R	0.82	0.52	31	53	1.40	1.61	358
HCMA1305-1R0-R	1.00	0.64	29	50	2.10	2.42	275
HCMA1305-1R5-R	1.50	0.96	23	48	2.75	3.16	225
HCMA1305-1R8-R	1.80	1.15	21	40	4.00	4.60	216
HCMA1305-2R2-R	2.20	1.41	20	32	4.60	5.29	191
HCMA1305-3R3-R	3.30	2.11	15	32	7.70	9.20	170
HCMA1305-4R7-R	4.70	3.01	12	27	11.0	12.7	161
HCMA1305-5R6-R	5.60	3.58	11.5	22	12.0	13.8	142
HCMA1305-6R8-R	6.80	4.35	11	21	13.0	15.0	129
HCMA1305-7R8-R	7.80	4.99	10	18.5	16.8	19.4	117
HCMA1305-8R2-R	8.20	5.25	9.5	18	17.5	20.1	117
HCMA1305-100-R	10.0	6.40	9.0	16	19.0	21.9	90
HCMA1305-150-R	15.0	9.60	7.7	13	29.0	33.4	74
HCMA1305-220-R	22.0	14.1	6.2	10	45.0	51.8	63
HCMA1305-330-R	33.0	21.1	5.2	8	74.5	85.5	48

- 1. Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.25V $_{\rm rms'}$ 0.0Adc, +25°C.
- 2. Full Load Inductance (FLL) Test Parameters: 100kHz, 0.25V_{mst}, I_{sat}, @ +25°C.
- 3.1_{rms}: DC current for an approximate temperature rise of 40°C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed 125°C under worst case operating conditions verified in the end application.
- 4. I_{sat} : Peak current for approximately 20% rolloff at +25°C.
- 5. K-factor: Used to determine B $_{_{\rm PP}}$ for core loss (see graph). B $_{_{\rm PP}}$ = K * L * ΔI . B $_{_{\rm PP}}$: (Gauss), K: (K-factor from table), L: (Inductance in μH), ΔI (Peak to peak ripple current in amps).
- 6. Part Number Definition: HCMA1305-yyy-R
 - HCMA1305 = Product code and size
 - yyy= Inductance value in μH , R = decimal point, if no R is present then third character = number of zeros.
 - "-R" suffix = RoHS compliant

Dimensions - mm

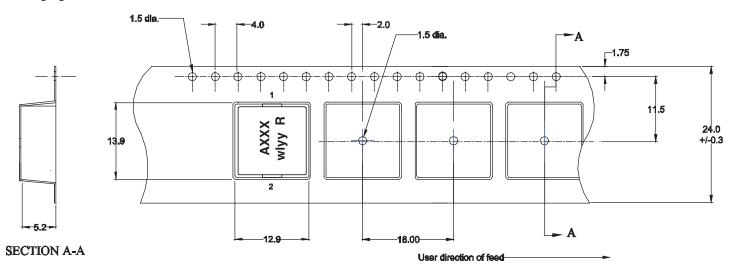


Part Marking: $A = Automotive \ grade$, $xxx = Inductance \ value \ in \ \mu H$, $R = decimal \ point$, if no R is present, third character = number of zeros, wlyy = (Date Code), $R = (Revision \ Level)$ All soldering surfaces to be coplanar within 0.10 millimeters.

Tolerances are ± 0.3 millimeters unless stated otherwise.

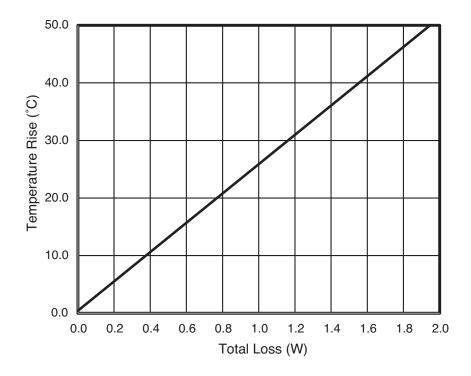
Color: Grey.

Packaging information - mm

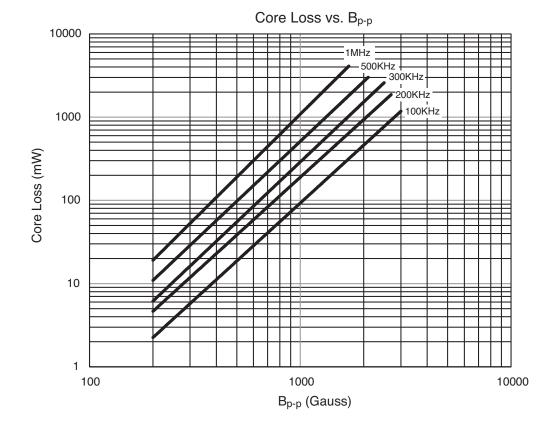


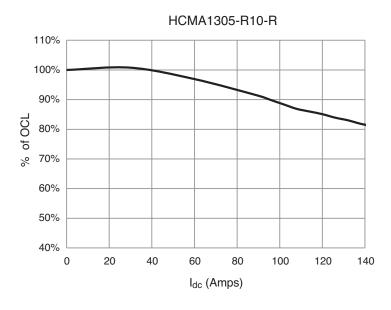
Supplied in tape and reel packaging, 400 parts per 13" diameter reel.

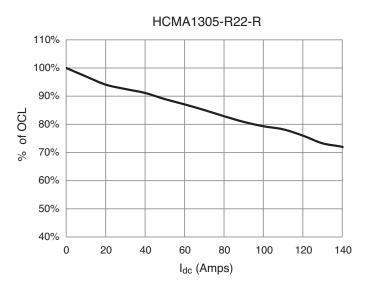
Temperature rise vs. total loss

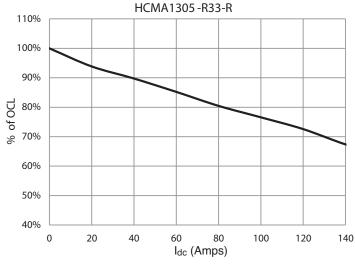


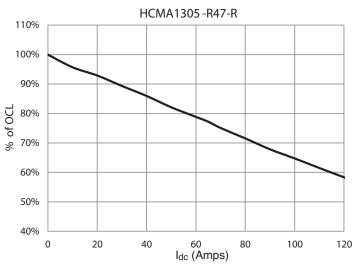
Core loss

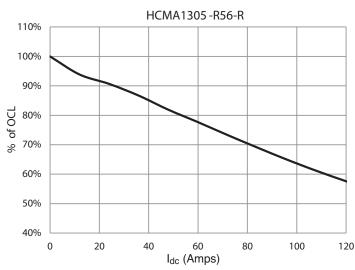


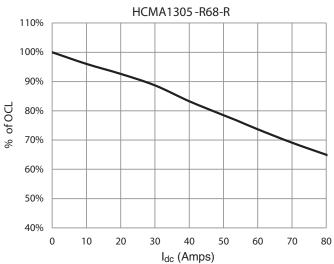


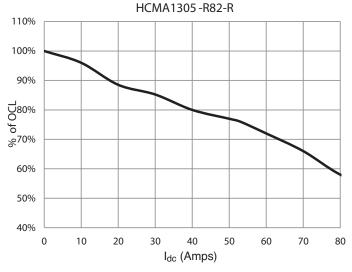


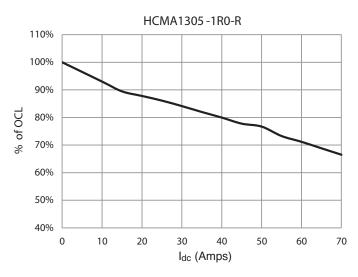


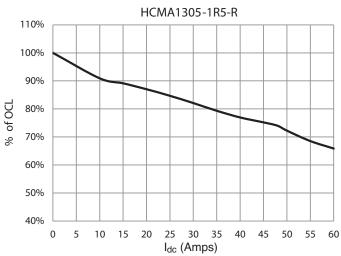


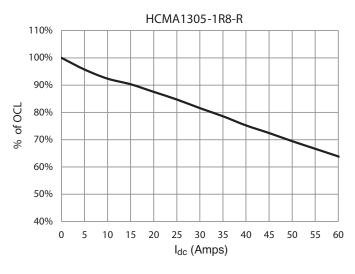


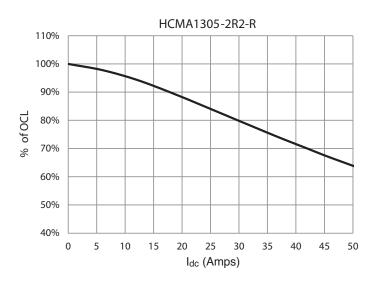


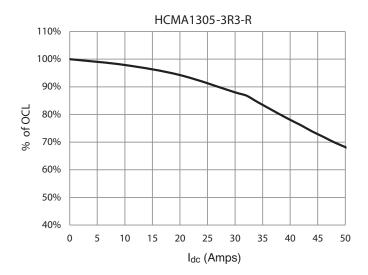


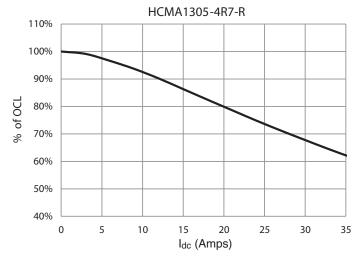


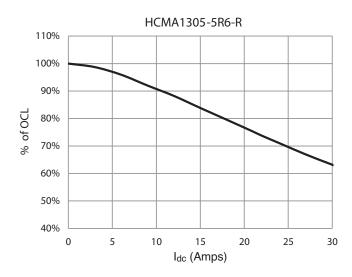


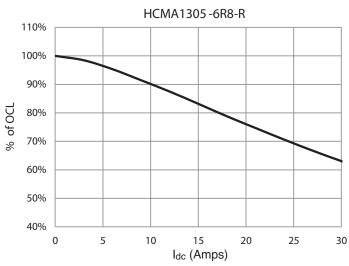


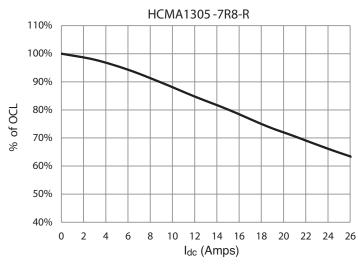


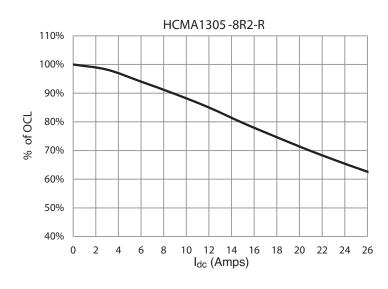


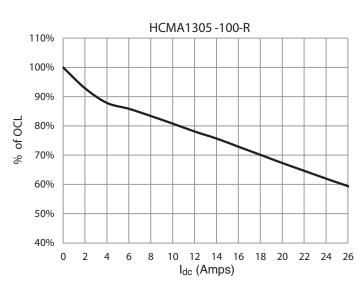


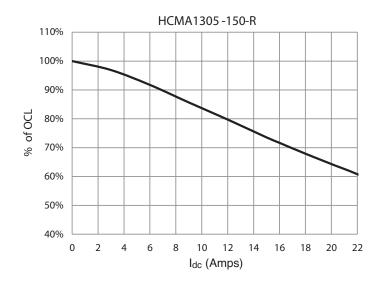


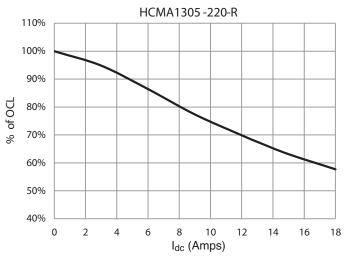


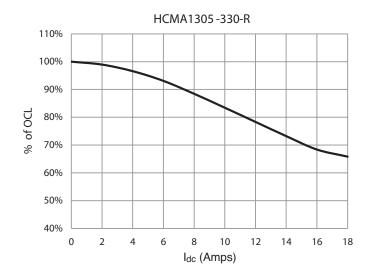












Solder reflow profile

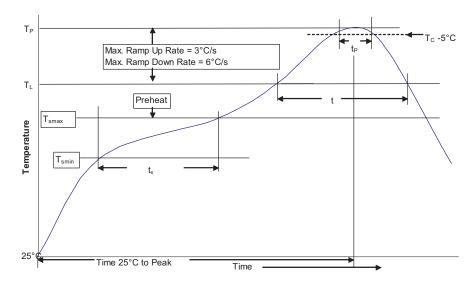


Table 1 - Standard SnPb Solder (T_c)

Package	Volume mm³	Volume mm³
Thickness	<350	≥350
<2.5mm	235°C	220°C
≥2.5mm	220°C	220°C

Table 2 - Lead (Pb) Free Solder (Tc)

Package Thickness	Volume mm³ <350	Volume mm³ 350 - 2000	Volume mm³ >2000
<1.6mm	260°C	260°C	260°C
1.6 - 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

Reference JDEC J-STD-020D

Profile Feature		Standard SnPb Solder	Lead (Pb) Free Solder	
Preheat and Soak	• Temperature min. (T _{smin})	100°C	150°C	
	Temperature max. (T _{smax})	150°C	200°C	
	• Time (T _{smin} to T _{smax}) (t _s)	60-120 Seconds	60-120 Seconds	
Average ramp up rate T _{Smax} to T _p		3°C/ Second Max.	3°C/ Second Max.	
Liquidous temperature (TL)		183°C	217°C	
Time at liquidous (t _L)		60-150 Seconds	60-150 Seconds	
Peak package body temperature (T _P)*		Table 1	Table 2	
Time $(t_p)^{**}$ within 5 °C of the specified classification temperature (T_c)		20 Seconds**	30 Seconds**	
Average ramp-down rate (T _p to T _{smax})		6°C/ Second Max.	6°C/ Second Max.	
Time 25°C to Peak Temperature		6 Minutes Max.	8 Minutes Max.	

 $^{^{\}star}$ Tolerance for peak profile temperature ($T_{\rm p}$) is defined as a supplier minimum and a user maximum.

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^{**} Tolerance for time at peak profile temperature (t_0) is defined as a supplier minimum and a user maximum.